



NOTE:

1. Applicable size of IC package : IC body size 4.4 x 6.5 mm
IC outer size 6.4 x 6.5 mm
IC height Max. 2.5mm

2. Tolerance: ± 0.1

Part No.	HSPACK20BG	
IC package	Rectangle	
Pin count	20Pin	
Lead pitch	0.65mm	
Unit : mm	Design : M.M.	
TET TOKYO ELETECH CORP.		